



Product Summary

V _{(BR)DSS}	R _{DS(on)TYP}	I _D
20V	18mΩ@10V	4A
	20mΩ@4.5V	
	25mΩ@2.5V	

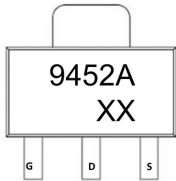
Feature

- Trench Technology Power MOSFET
- Low R_{DS(ON)}
- Low Gate Charge
- Low Gate Resistance

Application

- Power Switching Application

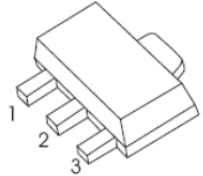
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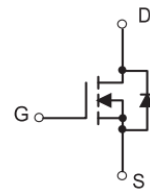
9452A = Device Code
XX = Date Code

SOT-89-3L

1. GATE
2. DRAIN
3. SOURCE



Schematic diagram



ABSOLUTE MAXIMUM RATINGS (T_A = 25°C unless otherwise noted)

Parameter	Symbol	Value	Unit
Drain - Source Voltage	V _{DS}	20	V
Gate - Source Voltage	V _{GS}	±12	V
Continuous Drain Current ^{1,5}	I _D	4	A
	T _A = 25°C		
Pulsed Drain Current ²	I _{DM}	16	A
Power Dissipation ^{4,5}	P _D	0.48	W
	T _A = 25°C		
Thermal Resistance from Junction to Ambient ⁵	R _{θJA}	260	°C/W
Junction Temperature	T _J	150	°C
Storage Temperature	T _{STG}	-55~ +150	°C

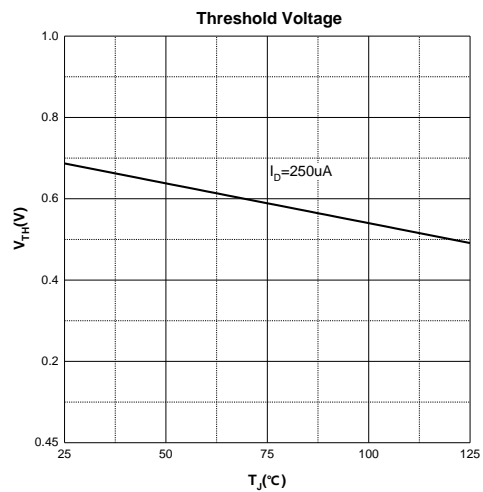
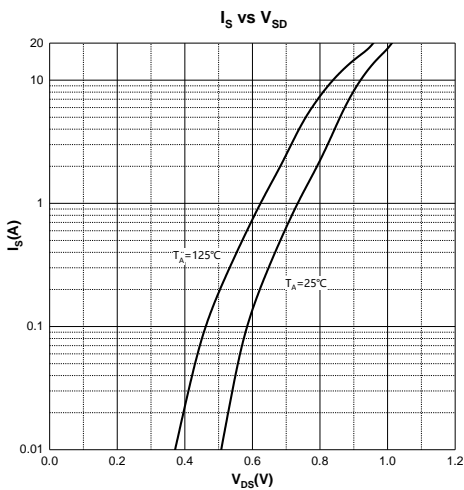
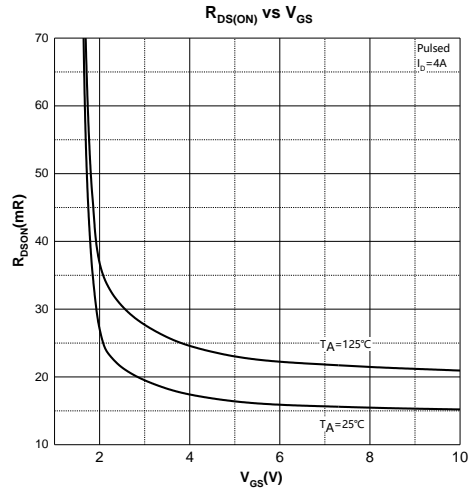
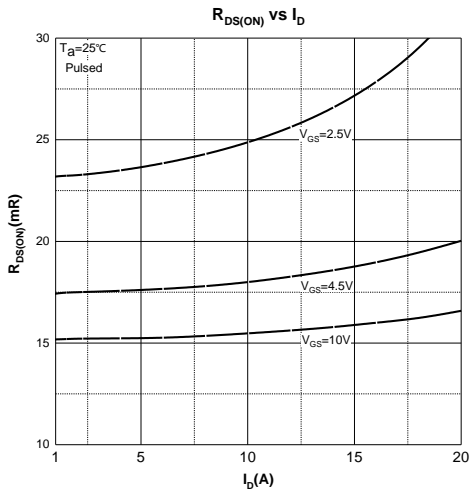
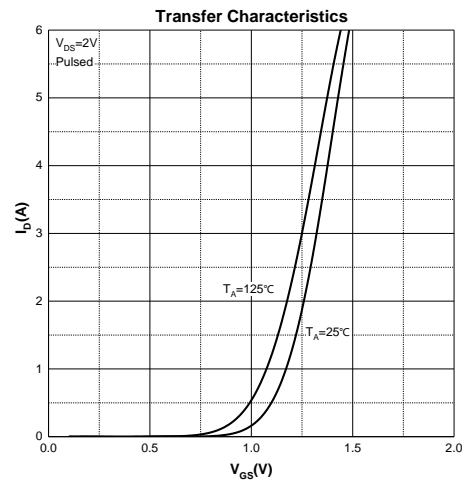
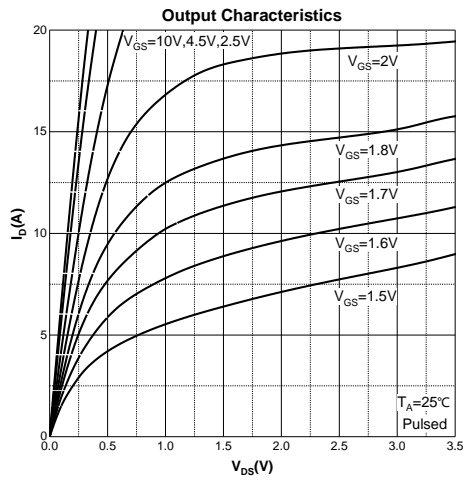
MOSFET ELECTRICAL CHARACTERISTICS ($T_J = 25^\circ\text{C}$ unless otherwise noted)

Parameter	Symbol	Test Condition	Min	Type	Max	Unit
Off Characteristics						
Drain - Source Breakdown Voltage	$V_{(BR)DSS}$	$V_{GS} = 0V, I_D = 250\mu A$	20			V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS} = 16V, V_{GS} = 0V$			1	μA
Gate - Body Leakage Current	I_{GSS}	$V_{GS} = \pm 12V, V_{DS} = 0V$			± 100	nA
On Characteristics³						
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\mu A$	0.4	0.7	1	V
Drain-source On-resistance	$R_{DS(on)}$	$V_{GS} = 10V, I_D = 4A$		18	38	m Ω
		$V_{GS} = 4.5V, I_D = 4A$		20	50	
		$V_{GS} = 2.5V, I_D = 3A$		25	80	
Forward Transconductance	g_{FS}	$V_{DS} = 4.5V, I_D = 4A$	3			S
Dynamic Characteristics						
Input Capacitance	C_{iss}	$V_{DS} = 10V, V_{GS} = 0V, f = 1MHz$		336		pF
Output Capacitance	C_{oss}			78		
Reverse Transfer Capacitance	C_{rss}			70		
Gate Resistance	R_g	$V_{DS} = 0V, V_{GS} = 0V, f = 1MHz$		1.6		Ω
Switching Characteristics						
Total Gate Charge	Q_g	$V_{DS} = 10V, V_{GS} = 4.5V, I_D = 4A$		6		nC
Gate-source Charge	Q_{gs}			1		
Gate-drain Charge	Q_{gd}			1.7		
Turn-on Delay Time	$t_{d(on)}$	$V_{DD} = 10V, V_{GS} = 4.5V,$ $R_L = 2.5\Omega, R_G = 3\Omega$		4		ns
Turn-on Rise Time	t_r			15		
Turn-off Delay Time	$t_{d(off)}$			20		
Turn-off Fall Time	t_f			25		
Source - Drain Diode Characteristics						
Diode Forward Voltage ³	V_{SD}	$V_{GS} = 0V, I_S = 4A$			1.2	V

Notes :

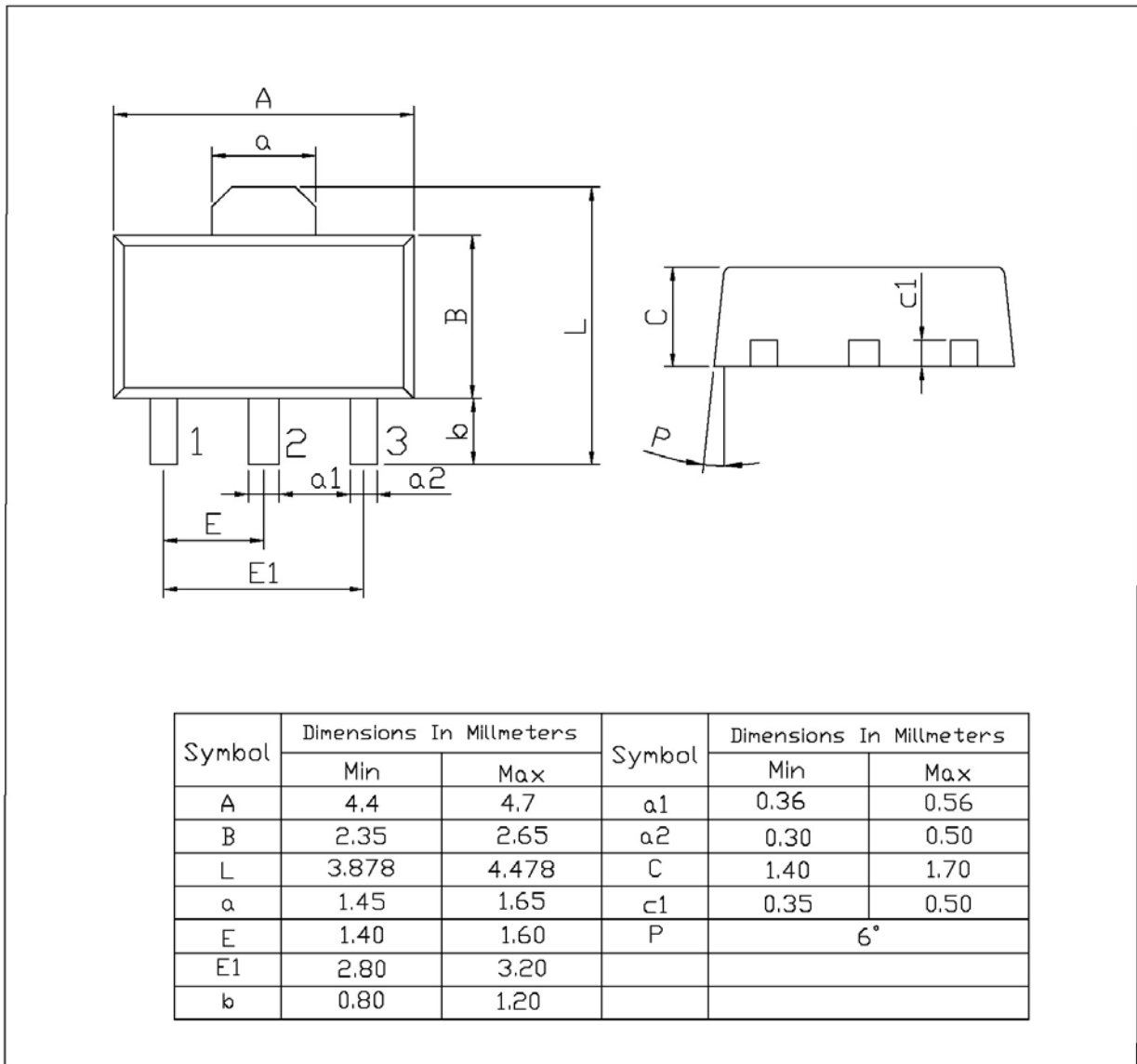
- 1.The maximum current rating is limited by package.
- 2.Pulse Test : Pulse Width $\leq 10\mu s$, duty cycle $\leq 1\%$.
- 3.Pulse Test : Pulse Width $\leq 300\mu s$, duty cycle $\leq 2\%$.
- 4.The power dissipation P_D is limited by $T_{J(MAX)} = 150^\circ\text{C}$.
- 5.Device mounted on $1in^2$ FR-4 board with 2oz. Copper, in a still air environment with $T_A = 25^\circ\text{C}$.

Typical Characteristics



SOT-89

单位: mm



单击下面可查看定价，库存，交付和生命周期等信息

[>>GP\(格瑞宝\)](#)